

AMP-LATCH

TE Internal #: 746611-8

Ribbon Cable Connectors, Wire-to-Board, 14 Position, 2.54mm [.

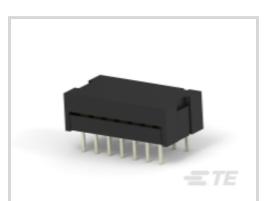
1in] Centerline, Vertical, Through Hole - Solder, Insulation

Displacement Crimp (IDC)

View on TE.com >



Connectors > PCB Connectors > Wire-to-Board Connectors > FFC, FPC & Ribbon Connectors > Ribbon Cable Connectors











Connector System: Wire-to-Board

Number of Positions: 14

Centerline (Pitch): 2.54 mm [.1 in]
PCB Mount Retention: Without
PCB Mount Orientation: Vertical

Features

Product Type Features

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Connector Type	Connector Assembly
Ribbon Cable Connector Header Type	Pin Header
Connector Product Type	Connector Assembly
Connector System	Wire-to-Board
Connector & Housing Type	Plug
Connector & Contact Terminates To	Printed Circuit Board, Wire & Cable
Configuration Features	
Configuration Features Number of Positions	14
	14 Vertical
Number of Positions	
Number of Positions PCB Mount Orientation	Vertical

 $5000~\mathrm{M}\Omega$

250 VAC

Insulation Resistance

Operating Voltage



Body Features

Daisy Chain	Without
Connector Profile	Standard

Contact Features

Contact Layout	Inline
PCB Contact Termination Area Plating Material Thickness	.762 μm[30 μin]
Contact Type	Pin
Wire Contact Termination Area Plating Material Thickness	.127 μm[5 μin]
Wire Contact Termination Area Plating Material	Gold
Contact Mating Area Plating Material Thickness	.76 μm[29.92 μin]
PCB Contact Termination Area Plating Material	Gold
Contact Base Material	Phosphor Bronze
Contact Current Rating (Max)	1 A

Termination Features

Rectangular Termination Post & Tail Thickness	.32 mm[.013 in]
Rectangular Termination Post & Tail Width	.5 mm[.02 in]
Termination Post & Tail Length	3.94 mm[.155 in]
Termination Method to Printed Circuit Board	Through Hole - Solder
Termination Method to Wire & Cable	Insulation Displacement Crimp (IDC)

Mechanical Attachment

Mating Alignment	With
PCB Mount Alignment	Without
Panel Mount Feature	Without
PCB Mount Retention	Without
Mating Alignment Type	Polarization
Mating Retention	Without
Connector Mounting Type	Board Mount

Housing Features

Housing Material	Thermoplastic
Housing Color	Black
Centerline (Pitch)	2.54 mm[.1 in]

Dimensions



Connector Length	20.02 mm[.788 in]
Connector Height	6.43 mm[.253 in]
Connector Width	10.67 mm[.42 in]
Wire Size	.051 – .15 mm²
PCB Thickness (Recommended)	3.18 mm[.125 in]
Accepts Wire Insulation Diameter Range	.81 – 1.07 mm[.032 – .042 in]
Row-to-Row Spacing	2 mm[.3 in]
Usage Conditions	
Operating Temperature Range	-65 – 105 °C[-85 – 221 °F]
Operation/Application	
Solder Process Feature	Solder Dipped
Circuit Application	Signal
Industry Standards	
the state of the s	
CSA File Number	LR 7189
	LR 7189 Recognized
CSA File Number	
CSA File Number UL Rating	Recognized
CSA File Number UL Rating Agency/Standard	Recognized CSA, UL
CSA File Number UL Rating Agency/Standard UL File Number	Recognized CSA, UL E28476
CSA File Number UL Rating Agency/Standard UL File Number UL Flammability Rating	Recognized CSA, UL E28476

Product Compliance

Packaging Method

For compliance documentation, visit the product page on TE.com>

EU RoHS Directive 2011/65/EU	Compliant
EU ELV Directive 2000/53/EC	Compliant
China RoHS 2 Directive MIIT Order No 32, 2016	No Restricted Materials Above Threshold
EU REACH Regulation (EC) No. 1907/2006	Current ECHA Candidate List: JAN 2021 (211) Candidate List Declared Against: JAN 2021 (211) Does not contain REACH SVHC
Halogen Content	Not Low Halogen - contains Br or Cl > 900 ppm.

Box & Tray, Tray



Solder Process Capability

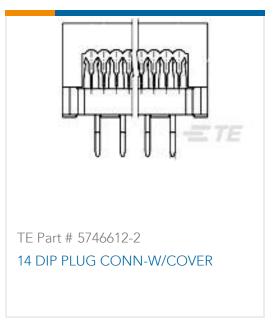
Wave solder capable to 265°C

Product Compliance Disclaimer

This information is provided based on reasonable inquiry of our suppliers and represents our current actual knowledge based on the information they provided. This information is subject to change. The part numbers that TE has identified as EU RoHS compliant have a maximum concentration of 0.1% by weight in homogenous materials for lead, hexavalent chromium, mercury, PBB, PBDE, DBP, BBP, DEHP, DIBP, and 0.01% for cadmium, or qualify for an exemption to these limits as defined in the Annexes of Directive 2011/65/EU (RoHS2). Finished electrical and electronic equipment products will be CE marked as required by Directive 2011/65/EU. Components may not be CE marked. Additionally, the part numbers that TE has identified as EU ELV compliant have a maximum concentration of 0.1% by weight in homogenous materials for lead, hexavalent chromium, and mercury, and 0.01% for cadmium, or qualify for an exemption to these limits as defined in the Annexes of Directive 2000/53/EC (ELV). Regarding the REACH Regulation, the information TE provides on SVHC in articles for this part number is based on the latest European Chemicals Agency (ECHA) 'Guidance on requirements for substances in articles' posted at this URL: https://echa.europa.eu/guidance-documents/guidance-onreach

Compatible Parts



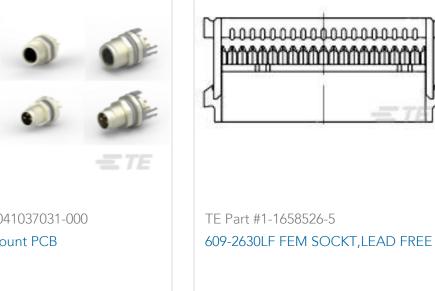


Customers Also Bought



TE Part #106081-1 Hard Metric Male Connector: Traditional Backplane, Mezzanine, 2mm



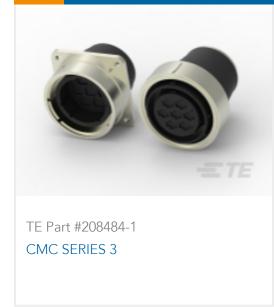


















Documents

Product Drawings

14 DIP PLUG CONN-W/COVER

English

CAD Files

3D PDF

3D

Customer View Model

ENG_CVM_CVM_746611-8_G.2d_dxf.zip

English

Customer View Model

ENG_CVM_CVM_746611-8_G.3d_igs.zip

English

Customer View Model

ENG_CVM_CVM_746611-8_G.3d_stp.zip

English

By downloading the CAD file I accept and agree to the **Terms and Conditions** of use.

Datasheets & Catalog Pages

Ribbon Cable Interconnect Solutions

English

Product Specifications

Application Specification

English

Instruction Sheets

Instruction Sheet (U.S.)

English

Agency Approvals

UL Report

English